

Differential Mini Amplified
SiSonic™ Microphone Specification
With Enhanced RF Protection – *Halogen Free*

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1. DESCRIPTION AND APPLICATION

1.1 Description

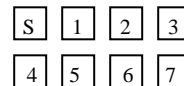
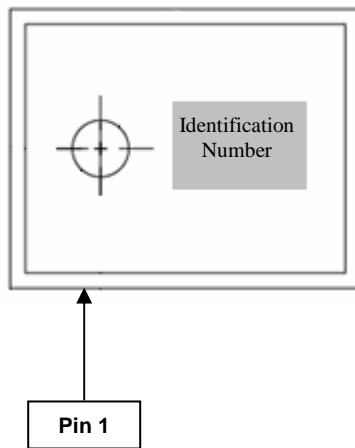
Differential Mini Amplified Surface Mount Silicon
Microphone with Enhanced RF Protection – *Halogen Free*

1.2 Application

Hand held telecommunication devices

2. PART MARKING

Identification Number Convention



S: Manufacturing Location

“S” – Knowles Electronics Suzhou
Suzhou, China

“No Alpha Character” – Knowles Electronics Itasca
Itasca, IL USA

“E” – Engineering Samples

Digits 1 – 7: Job Identification Number

3. TEMPERATURE RANGE

3.1 Operating Temperature Range: -40°C to +100°C

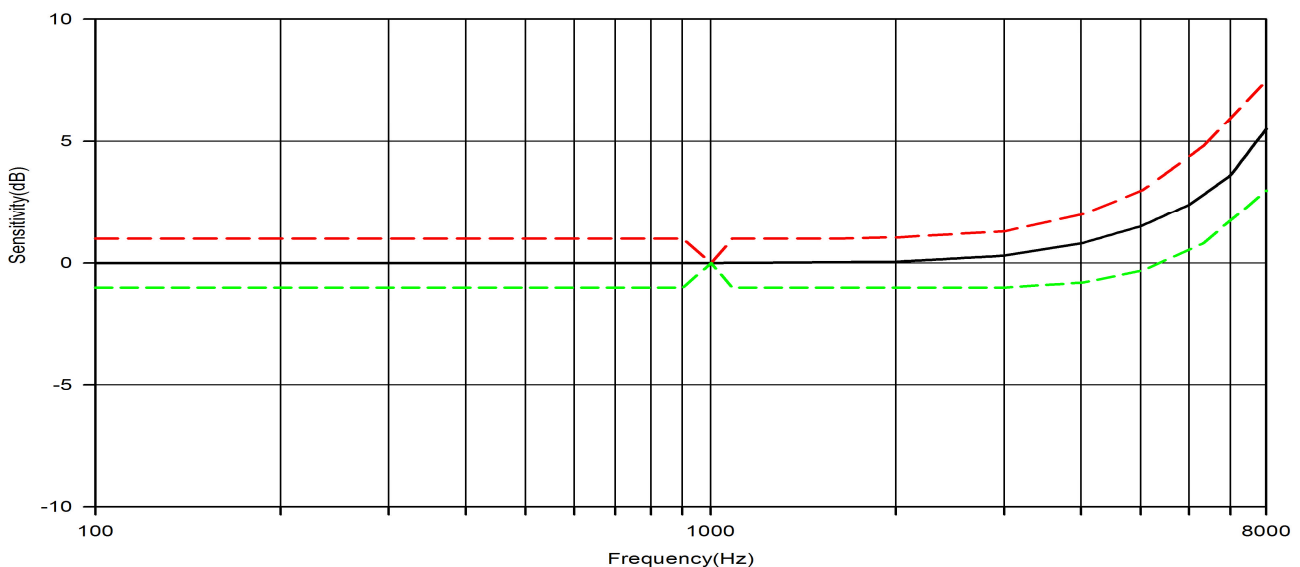
3.2 Storage Temperature Range: -40°C to +100°C

4. ACOUSTIC & ELECTRICAL SPECIFICATIONS

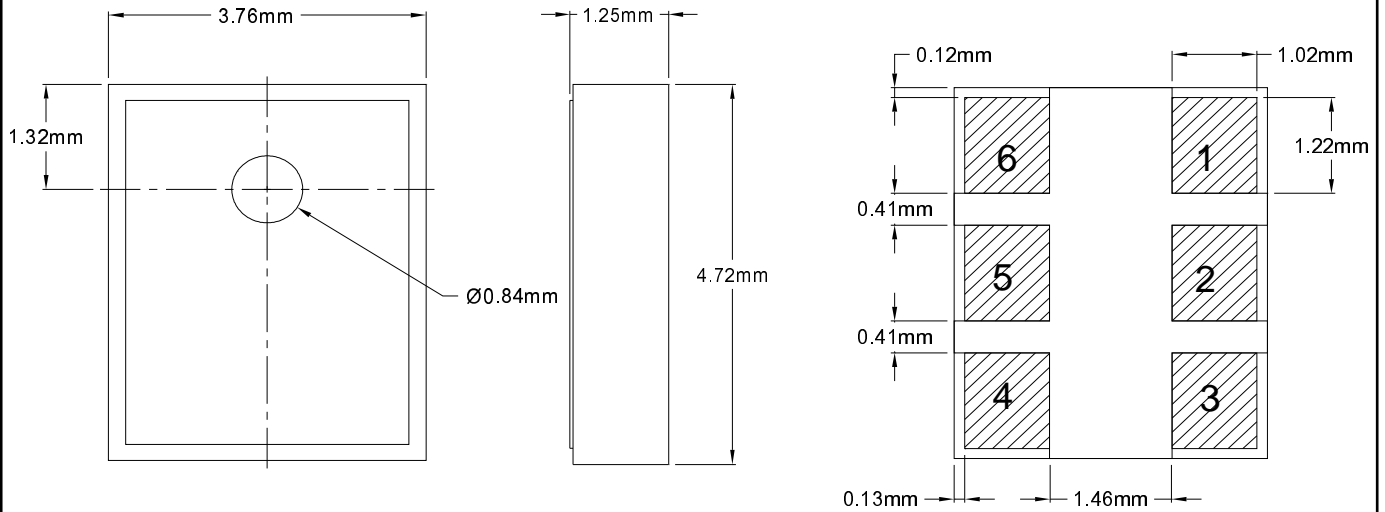
	Symbol	Condition	Limits			Unit
			Min.	Nom.	Max.	
Directivity		Omni-directional				
Sensitivity (Note 1)	S	@ 1kHz (0dB=1V/Pa)	-26	-22	-18	dB
Output impedance (per output terminal)	Z _{OUT}	@ 1kHz (0dB=1V/Pa)	n/a	n/a	100	Ω
Current Consumption	I _{DSS}	across 1.5 to 5.5 volts	0.100	n/a	0.500	mA
Signal to Noise Ratio	S/N	@ 1kHz (0dB=1V/Pa)	55	59	n/a	dB
Supply Voltage	V _s		1.5	n/a	5.5	V
Typical Input Referred Noise	ENL	A-weighted	n/a	35	n/a	dBA SPL
Sensitivity Loss across Voltage		Change in sensitivity over 5.5v to 1.5v	No Change Across Voltage Range			dB
Maximum Input Sound Level		At 100dB SPL, THD < 1% At 115dB SPL, THD = < 10%				dB

Note 1: Sensitivity is specified in differential mode at max gain. In differential mode with unity gain, sensitivity specification is -36 +/- 4dB. In single ended mode with unity gain, sensitivity specification is -42 +/- 4 dB.

5. FREQUENCY RESPONSE CURVE



6. MECHANICAL SPECIFICATIONS

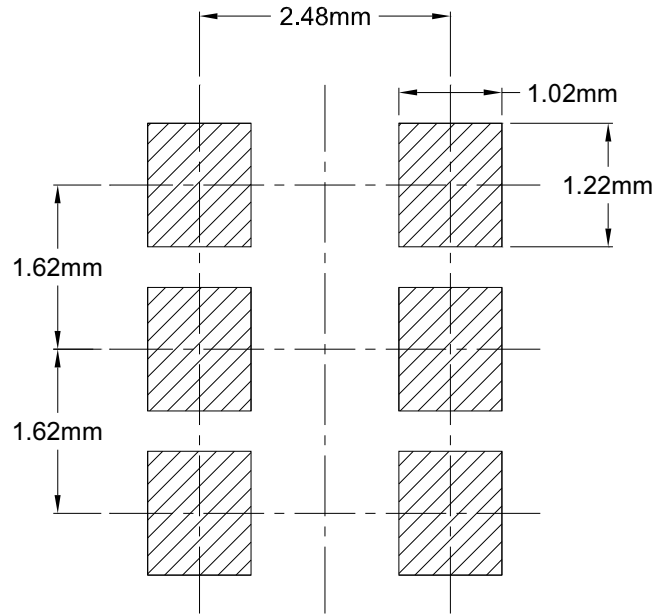


Pin Output	
Pin #	Function
1	Output +
2	Output -
3	Gain Control
4	Ground
5	No Connect or Ground
6	Power (Vdd)

Item	Dim.	Tol. (+/-)	Units
Height	1.25	0.10	mm
Length	4.72	0.10	mm
Width	3.76	0.10	mm
Short Edge to C.L. Port	1.32	0.25	mm
Long Edge to C.L. Port	1.88	0.25	mm
Weight	<0.08	grams	

Note: (Tolerance +/-0.15mm unless otherwise specified)
 * = Final Height dimension under review.

7. RECOMMENDED CUSTOMER LAND PATTERN

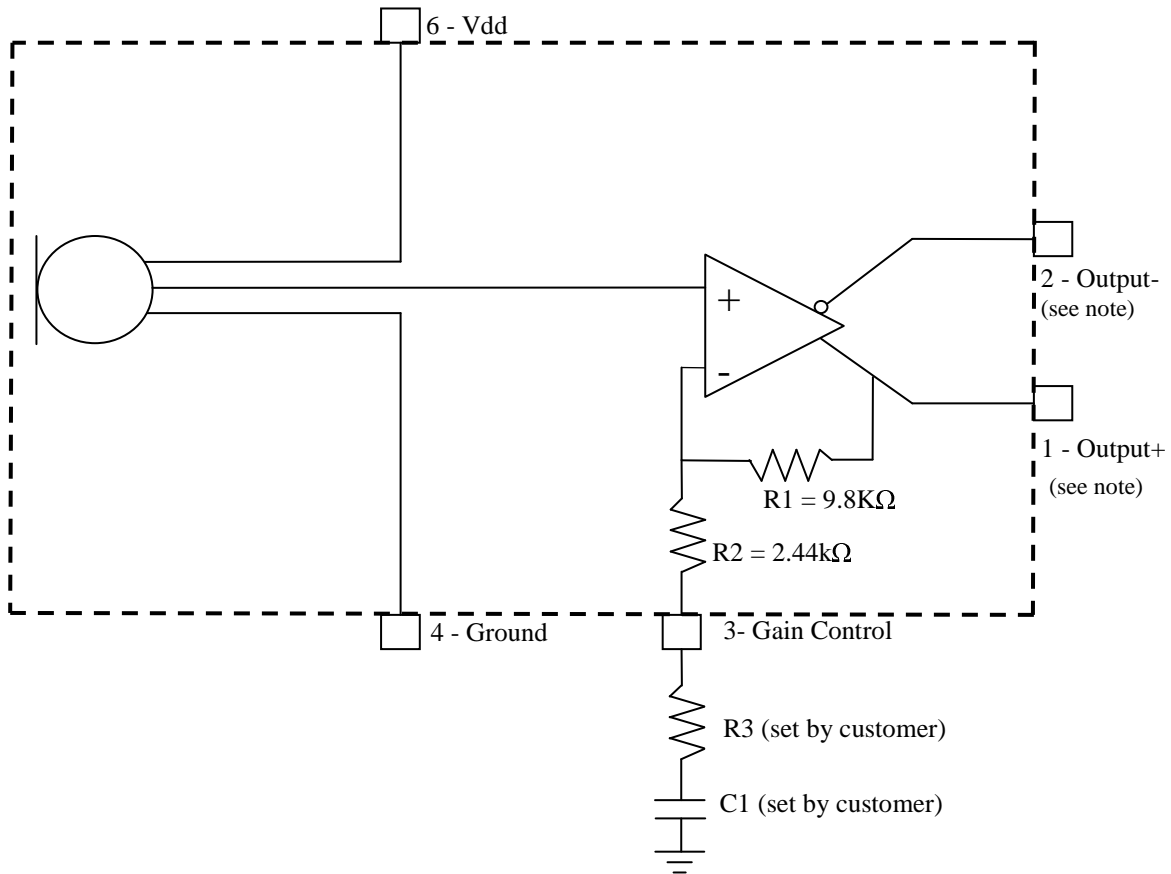


8. RECOMMENDED SOLDER STENCIL PATTERN

N/A

9. RECOMMENDED INTERFACE CIRCUIT

<u>Desired Gain</u>	<u>Pin 3 Termination Method</u>
Unity Gain (0dB)	Tie Terminal 3 (Gain Control) directly to Output+ (Terminal 1).
14dB Gain	Tie Terminal 3 (Gain Control) through C1 (0.47uF) to Ground.
Adjustable Gain	Add R3 and C1. Use formulas provided to calculate gain and high-pass crossover frequency, or contact Knowles for support.



Note: Customer is recommended to use DC-blocking capacitor to each output line (terminal 1 & 2) to guard against DC mismatch during start-up.

Setting Gain Formulas:

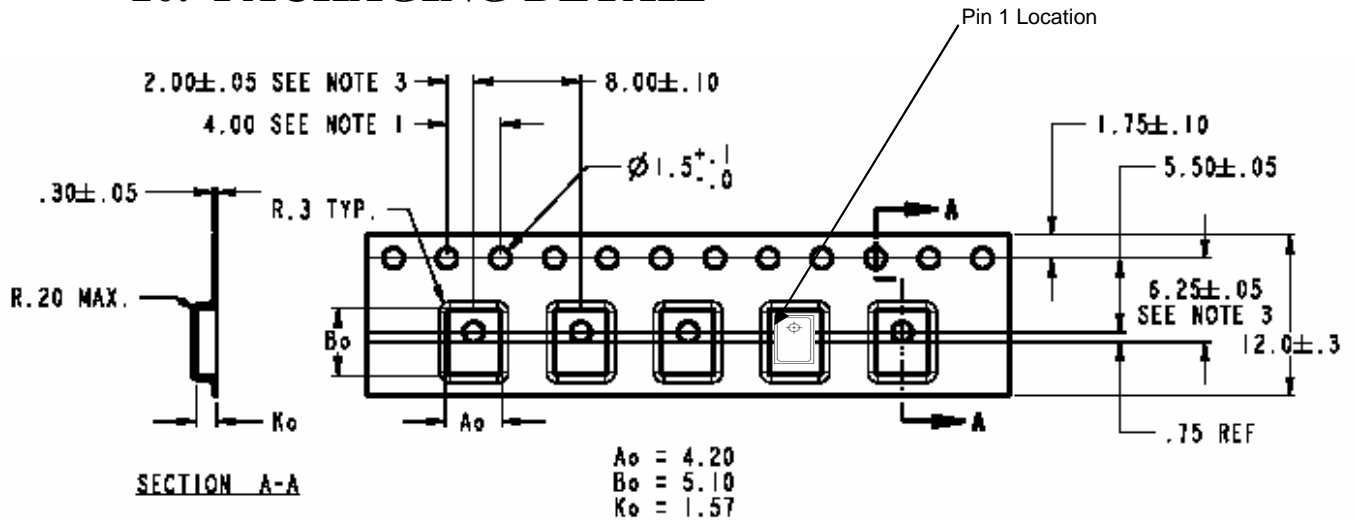
Gain of non-inverting differential Op-Amp is determined as:

$$G = (1 + \{ R1 / (R2 + R3) \}) \quad \text{Gain(dB)} = 20 * \log(G)$$

High-pass-filter Corner Frequency:

$$\text{C.F.} = 1 / \{ 2 * \pi * (R2 + R3) * C1 \}$$

10. PACKAGING DETAIL



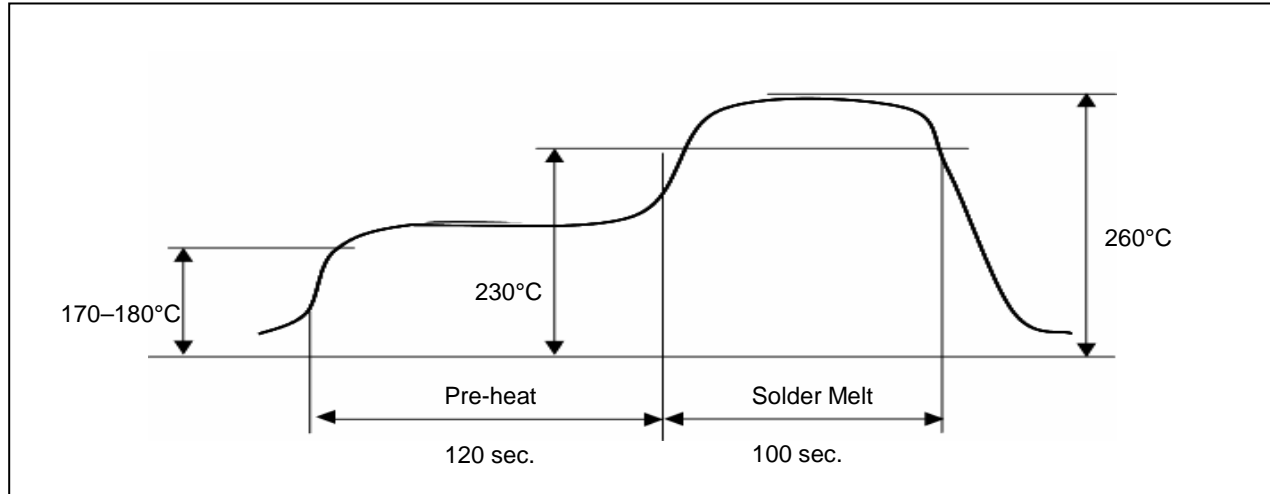
NOTES:

1. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ± 0.2 .
2. CAMBER IN COMPLIANCE WITH EIA 481.
3. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET.

<u>Model Number</u>	<u>Suffix</u>	<u>Reel Diameter</u>	<u>Quantity per Reel</u>
SPM0206HE3	-2	7"	1,200
SPM0206HE3	-3	13"	4,500
SPM0206HE3	-6	13"	4,800

Tape & Reel	Available in 13" and 7" diameter.
Empty Units	No consecutive empty pockets; No more than 3 empty pockets per reel. (Does not include empty pockets for leader/follower)

11. SOLDER REFLOW PROFILE



<i>Stage</i>	<i>Temperature Profile</i>	<i>Time (maximum)</i>
Pre-heat	170 ~ 180 C	120 sec.
Solder Melt	Above 230 C	100 sec.
Peak	260 C maximum	30 sec.

Notes:

1. Do not pull a vacuum over the port hole of the microphone. Pulling a vacuum over the port hole can damage the device.
2. Do not board wash after the reflow process. Board washing and cleaning agents can damage the device. Do not expose to ultrasonic processing or cleaning.
3. Number of Reflow = recommend no more than 3 cycles.

12. ADDITIONAL NOTES

- (A) Packaging (reference SiSonic_Packaging_Spec.pdf)
- (B) Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.
- (C) Exposure: Devices should not be exposed to high humidity, high temperature environment. MSL (moisture sensitivity level) Class 2A.
- (D) Out of bag: Maximum of 90 days out of ESD moisture sensitive bag, assuming maximum conditions of 30°C/70% R.H.

13. RELIABILITY SPECIFICATIONS

Note: After test conditions are performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

Test	Description
Thermal Shock	Microphone unit must operate when exposed to air-to-air thermal shock 100 cycles, from -40°C to +125°C. (IEC 68-2-4),
High Temperature Storage Test	Microphone unit must maintain sensitivity after storage at +105°C for 1,000 hours. (IEC 68-2-2 Test Ba)
Low Temperature Storage Test	Microphone unit must maintain sensitivity after storage at -40°C for 1,000 hours. (IEC 68-2-1 Test Aa)
High Temperature Operating Test	Microphone unit must operate within sensitivity specifications for 1,000 hours at 105°C. (IEC 68-2-2 Test Ba)
Low Temperature Operating Test	Microphone unit must operate within sensitivity specifications for 1,000 hours at -40°C. (IEC 68-2-1 Test Aa)
Humidity Test	Tested under Bias at 85°C/85% R.H. for 336 hours. (JESD22-A101A-B)
Vibration Test	Microphone unit must operate under test condition: 4 cycles, from 20 to 2,000 Hz in each direction (x,y,z), 48 minutes, using peak acceleration of 20g (+20%, -0%). (MIL 883E, method 2007.2, A)
Electrostatic Discharge	Tested to 8kV direct contact discharge to lid (mounted to PCB).
Reflow	Microphone is tested to 5 passes through reflow oven, with microphone mounted upside-down under conditions of 260°C for 30 seconds maximum.
Mechanical Shock	Microphone must operate after exposure to shock test of 10,000 G per IEC 68-2-27, Ea.

14. SPECIFICATION REVISIONS

Revision	Detailed Specification Changes	Date
A	Preliminary Specification Release	02-15-2006
B	Preliminary. Updated Reliability Specifications.	04-05-2006
C	Updated Section 10: Tape and Reel Specification	04-20-2006
D	Specification Release	08-04-2006
E	Update Product Description	12-12-2006
F	Update Product Identification; Add Taping Suffix -3	06-30-2008

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